

## Supplementary Materials

# Additive Manufacturing as a Means of Gas Sensor Development for Battery Health Monitoring

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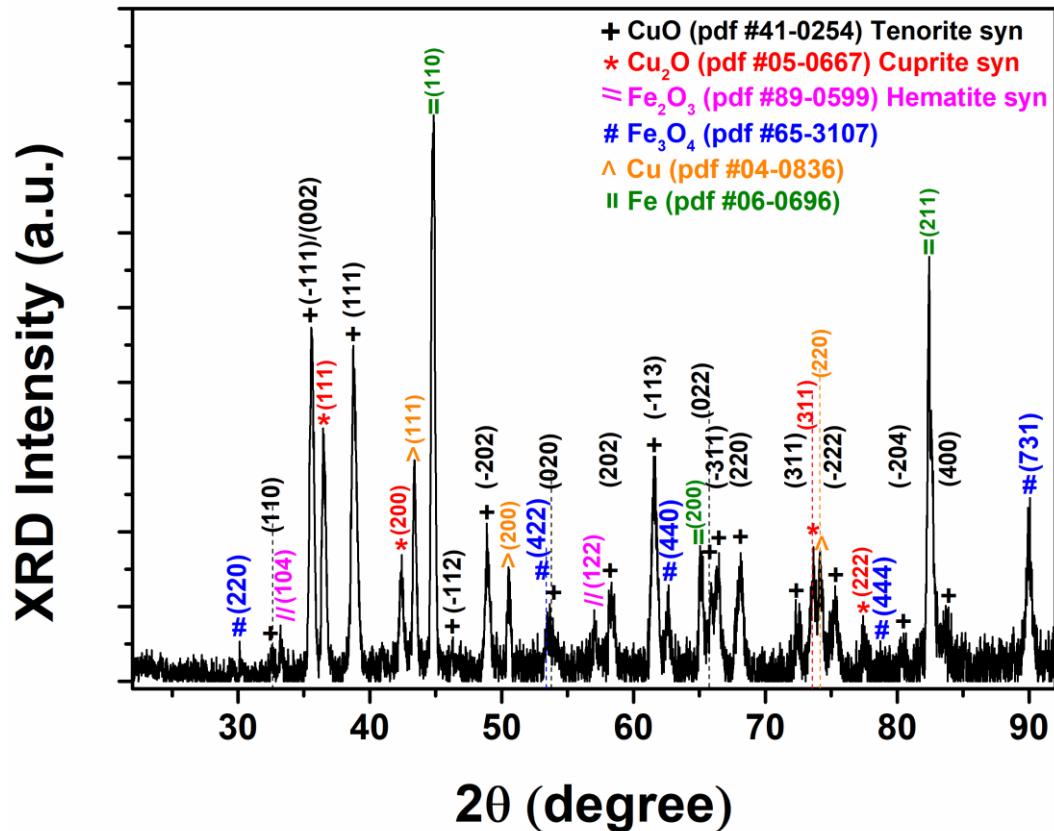
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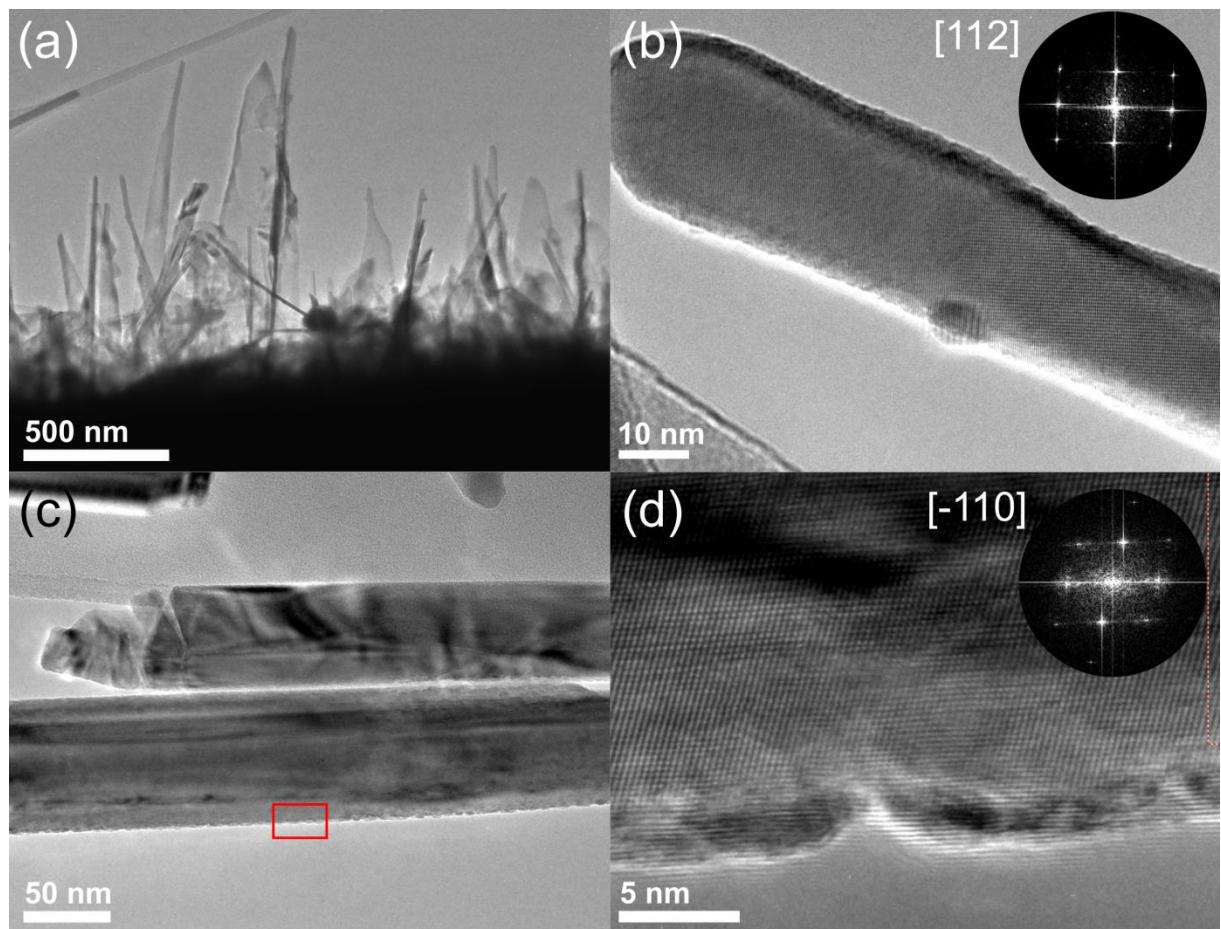
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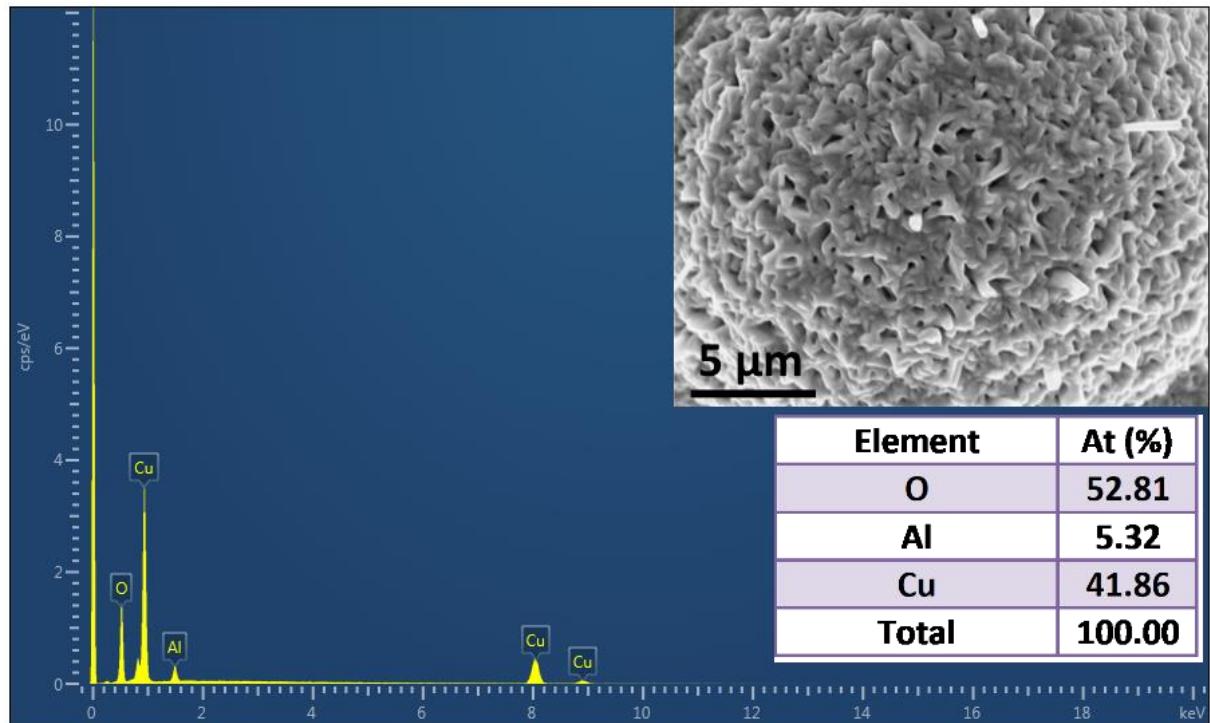
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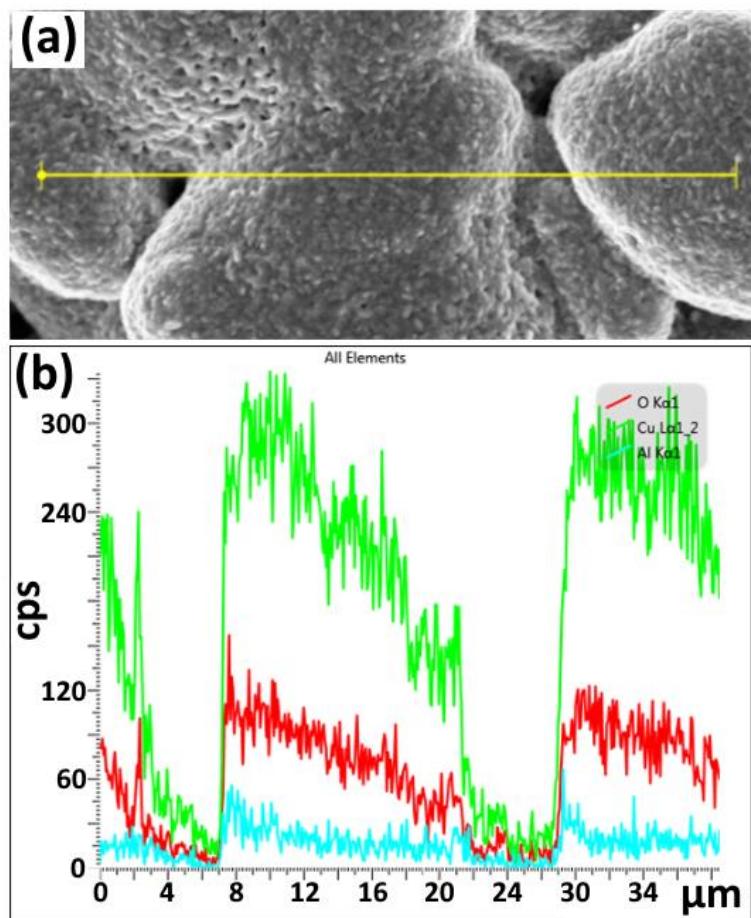
**Figure S1.** XRD diffractograms of the 3D printed copper and iron oxide heterostructure.



**Figure S2.** (a) TEM bright field micrograph of various iron oxide nanowires and nanospikes. (b) HRTEM micrograph of a single iron oxide nanowire with a diameter of 25 nm. FFT (inset) shows that the wire is fully crystalline  $\text{Fe}_3\text{O}_4$  oriented in ZA [112]. (c) shows two  $\text{CuO}$  nanowires with diameters of 65 and 80 nm respectively. (d) HRTEM and subsequent FFT (inset) of the area marked in (c) show that the  $\text{CuO}$  nanowires possess monoclinic  $\text{CuO}$  crystal structure with the lower wire being oriented along ZA [-110].



**Figure S3.** EDX spectrum with the elemental composition of the  $\text{Al}_2\text{O}_3/\text{CuO}$ -3D samples. Inset shows SEM image of the respective sample and region where spectrum was measured.



**Figure S4.** (a) SEM image and (b) EDX-line scan profile of Cu, O and Al taken along the three microparticles of CuO covered with a thin layer of Al<sub>2</sub>O<sub>3</sub>.